

Vaibhav Murali

<https://www.linkedin.com/in/vaibhavmurali/>
<https://vaibhavmurali.github.io/Website/>

murali.vaibhav95@gmail.com
Phone: +1-917-519-1685

| | | | | |
|--|--|---|--|--|
| OBJECTIVE | Interested in the field of Instrumentation and Electronics Engineering | | | |
| EDUCATION | University of Southern California (USC) | CGPA: 3.6/4.0 | | |
| | Master of Science (M.S.), Biomedical Engineering | May 2019 | | |
| | SSN College of Engineering, Anna University | CGPA: 8.01/10.0 | | |
| | Bachelor of Engineering (B.E.), Biomedical Engineering | June 2017 | | |
| TECHNICAL SKILLS | Languages | C, C++, Python, Bash Programming | | |
| | Software | Arduino IDE, Atmel Studio, MATLAB, LABVIEW, LT-Spice, Eagle, Cadence Virtuoso | | |
| | Hardware | Oscilloscopes, Signal Generator, Soldering, DAC, ADC, DMM, Electrical Safety Analyzers | | |
| | Platform | Arduino, Intel 8051, Cadence Allegro, TI MSP 430, Solidworks, PIC, Raspberry Pi, BioRadio | | |
| EXPERIENCE | Electronics Engineer | June 2019 | | |
| | NOWDx Instrument Division (NID) | Los Angeles, CA | | |
| | <ul style="list-style-type: none">• Design of PCBs (Rigid & Flex, Multilayer PCBs) using Eagle & Cadence Allegro• Creating test environment by making PCBs in-house using through-hole & SMD components• Verification and validation of PCBs using Python & Bash programming• Debugging electronic circuits using DMM & oscilloscopes• Writing documents according to 21CFR820 standard. | | | |
| | Engineering Intern | April 2019 | | |
| | NOWDx Instrument Division (NID) | Los Angeles, CA | | |
| | <ul style="list-style-type: none">• Responsible for testing of PCBs using python & bash programming. Also, responsible for collecting data & reporting issues to project manager | | | |
| | Graduate Teaching Assistant | August 2018 | | |
| | University of Southern California | Los Angeles, CA | | |
| | <ul style="list-style-type: none">• Assisted in setting up, monitoring, grading exams & laboratory experiments in instrumentation laboratory and signal processing laboratory. Also, taken classes for engineering graduate students | | | |
| | Laboratory Student- Digital MOS VLSI | August 2018 | | |
| University of Southern California | Los Angeles, CA | | | |
| <ul style="list-style-type: none">• Design of circuits involving area, delay & power minimisation. Includes design, layout, extraction, simulation & automatic synthesis | | | | |
| PROJECTS | Cast Simulator | | | |
| | <ul style="list-style-type: none">• Designing a model arm embedded with temperature and pressure sensors to provide real-time feedback to surgeons• Working in collaboration with Children’s Hospital Los Angeles (CHLA) | | | |
| | Design of Artificial Neuron | | | |
| | <ul style="list-style-type: none">• Implemented Mealy Machine circuit using Cadence Virtuoso• Involved flipflops & compound gates to replicate the firing of neurons | | | |
| | Laboratory Model of a Low-Cost Dialysis Machine | | | |
| | <ul style="list-style-type: none">• Headed a team of three to model a low cost dialysis machine using refurbished materials & cost effective electronic components• Engineered a machine that performs basic operations such as monitoring pressure, temperature & detecting air bubbles present inside blood drawn from patient | | | |
| | Design of ultrasound airflow transducer | | | |
| | <ul style="list-style-type: none">• Developed an ultrasound transducer model in LT SPICE and simulated it• Replicated model for three flow rates and observed linear relationship of volume over time | | | |
| | COURSEWORK | <ul style="list-style-type: none">• Graduate: MOS VLSI Circuit design, BIO-MEMS and Nanotechnology, Applied Electrophysiology, Bioinstrumentation, Ultrasonic Imaging, Signals & Systems• Undergraduate: Bio-Optics, Digital Image Processing, Analog and Digital Integrated Circuits, Neural Networks, OOPS & Data Structures, Biomechanics, Sensors & Measurements | | |
| | | | | |
| WORK AUTHORIZATION | <ul style="list-style-type: none">• Eligible to work in the United States of America under Optional Practical Training (OPT)• Would require H1B visa sponsorship | | | |
| | | | | |